



### N-CHANNEL ENHANCEMENT MODE MOSFET

### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> T <sub>A</sub> = +25°C
20V	$24m\Omega$ @ $V_{GS} = 4.5V$	7A
200	$28m\Omega @ V_{GS} = 2.5V$	5A

### **Description**

This new generation MOSFET is designed to minimize the on-state resistance ( $R_{DS(ON)}$ ) yet maintain superior switching performance, which makes it ideal for high-efficiency power management applications.

### **Applications**

- Backlighting
- DC-DC Converters
- Power Management Functions

### **Features and Benefits**

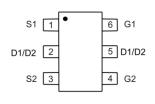
- Low On-Resistance
- Low-Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q101, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.
- https://www.diodes.com/quality/product-definitions/

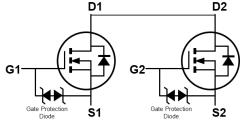
### **Mechanical Data**

- Case: TSOT26
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram
- Terminals: Finish—Matte Tin Annealed Over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 (©3)
- Weight: 0.013 grams (Approximate)









TSOT26

Top View

Equivalent Circuit

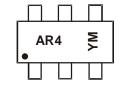
### Ordering Information (Note 4)

Part Number	Case	Packaging
DMN2024UVT-7	TSOT26	3000/Tape & Reel
DMN2024UVT-13	TSOT26	10.000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

# Marking Information



AR4 = Product Type Marking Code YM = Date Code Marking Y or  $\overline{Y}$  = Year (ex: G = 2019) M = Month (ex: 9 = September)

Date Code Key

Date Odde Ney												
Year	2018		2019	2020		2021	2022	:	2023	2024		2025
Code	F		G	Н			J		K	L		М
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



# 

Characteristic	Symbol	Value	Unit
Drain-Source Voltage	$V_{DSS}$	V	
Gate-Source Voltage	V <sub>GSS</sub>	±10	V
Continuous Drain Current (Note 6) V <sub>GS</sub> = 4.5V	I <sub>D</sub>	7.0 5.0	А
Maximum Continuous Body Diode Forward Curr	Is	2.3	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle =	I <sub>DM</sub>	35	Α

### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)		$P_{D}$	1.0	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R <sub>OJA</sub>	124	°C/W
Total Power Dissipation (Note 6)		P <sub>D</sub>	1.6	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R <sub>OJA</sub>	78	°C/W
Operating and Storage Temperature Range		T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C

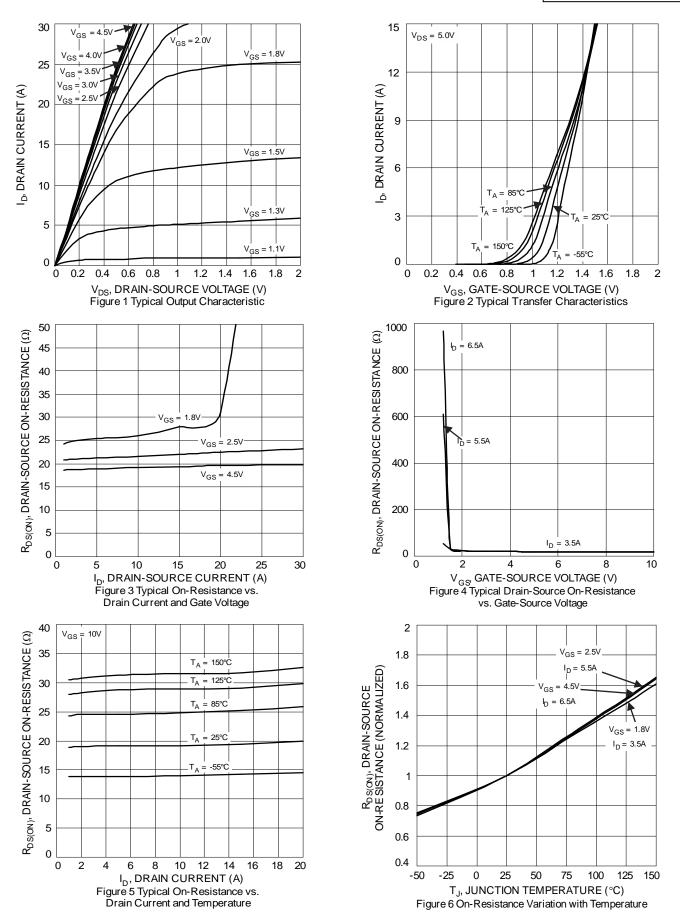
# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

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Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						T
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	20	_		V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current $T_J = +25^{\circ}C$	I <sub>DSS</sub>	_	_	1.0	μA	$V_{DS} = 20V$ , $V_{GS} = 0V$
Gate-Source Leakage	$I_{GSS}$	_	_	±10	μΑ	$V_{GS} = \pm 8V$ , $V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	0.5		0.9	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
			19	24		$V_{GS} = 4.5V, I_D = 6.5A$
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	22	28	mΩ	$V_{GS} = 2.5V, I_D = 5.5A$
			25	34		$V_{GS} = 1.8V, I_D = 3.5A$
Diode Forward Voltage	V <sub>SD</sub>	_	0.9	1.2	V	$V_{GS} = 0V$ , $I_D = 5A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	_	647	_	pF	
Output Capacitance	Coss	_	78	-	pF	$V_{DS} = 10V, V_{GS} = 0V$ - f = 1.0MHz
Reverse Transfer Capacitance	C <sub>rss</sub>	_	38		pF	1 = 1.0WHZ
Gate Resistance	$R_g$	_	628	_	Ω	$V_{DS}$ = 0V, $V_{GS}$ = 0V, f = 1MHz
Total Gate Charge	Qg	_	7.1	_	nC	
Gate-Source Charge	Qgs	_	0.9	1	nC	$V_{GS} = 4.5V, V_{DS} = 10V, I_D = 6.5A$
Gate-Drain Charge	$Q_{gd}$	_	0.7	1	nC	
Turn-On Delay Time	t <sub>D(ON)</sub>	_	98	1	ns	
Turn-On Rise Time	t <sub>R</sub>	_	140	_	ns	$V_{DS} = 10V, V_{GS} = 4.5V,$
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	1024	_	ns	$R_L = 10\Omega$ , $R_G = 6\Omega$ , $I_D = 1A$
Turn-Off Fall Time	t <sub>F</sub>	_	434	1	ns	
Reverse Recovery Time	t <sub>RR</sub>	_	245	_	ns	$I_F = 1.0A$ , $di/dt = 100A/\mu s$
Reverse Recovery Charge	Q <sub>RR</sub>	_	149	_	nC	$I_F = 1.0A$ , $di/dt = 100A/\mu s$

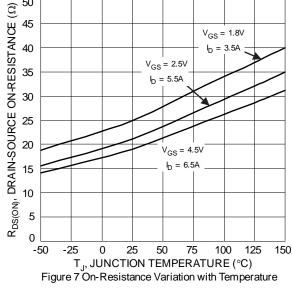
Notes:

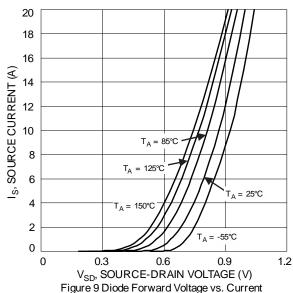
- 5. Device mounted on FR-4 PCB, with minimum recommended pad layout.
- 6. Device mounted on 1" x 1" FR-4 PCB with high-coverage 2oz. copper, single sided.
  7. Short duration pulse test used to minimize self-heating effect.
  8. Guaranteed by design. Not subject to product testing.

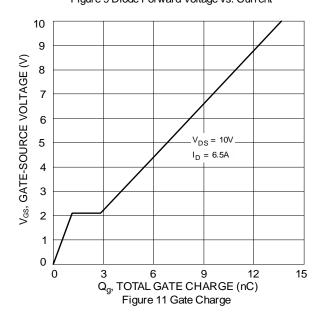


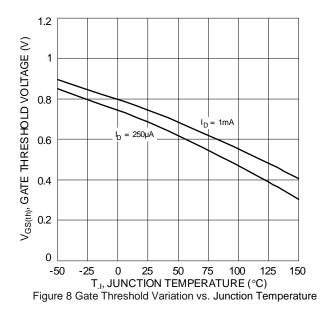


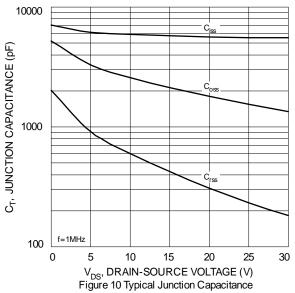


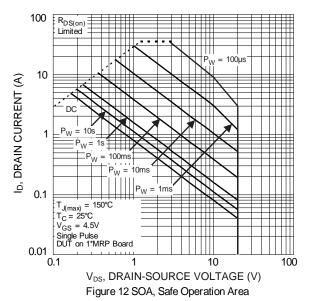




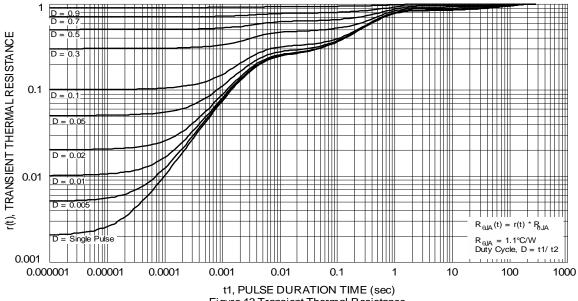










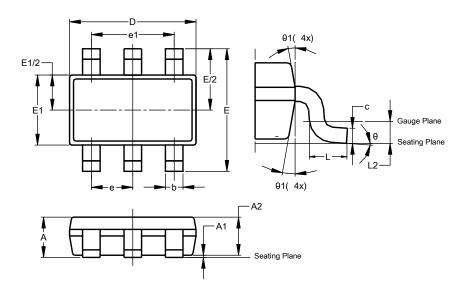




### **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### TSOT26

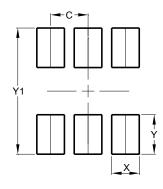


	TSOT26							
Dim	Min	Max	Тур					
Α	1	1.00	_					
A1	0.010	0.100	-					
A2	0.840	0.900	_					
D	2.800	3.000	2.900					
Е	2	.800 BS	С					
E1	1.500	1.700	1.600					
b	0.300	0.450	-					
С	0.120	0.200	_					
е	0.950 BSC							
e1	1.900 BSC							
L	0.30	0.50	-					
L2	0.250 BSC							
θ	0°	8°	4°					
θ1	4° 12°		_					
Α	All Dimensions in mm							

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### TSOT26



Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3.199



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